

SPECIFICATIONS FOR GOLD CERAMIC CPU

SPECUFICATIONS

Specification	Details
Product Name	Gold Ceramic CPU Scrap
Material Type	Ceramic Processor with Gold-Plated Components
Category	Electronic Scrap (E-Scrap) / Precious Metal Bearing Material
Composition	Ceramic Body, Gold-Plated Pins, Gold Bonding Wires, Silicon Chip
Color	Gold, White, Brown, or Green Ceramic
Gold Content	Varies by CPU Model and Manufacturer
Physical Condition	Used, Obsolete, Recovered from Electronic Equipment
Source	Computers, Servers, Telecommunications Equipment, Industrial Electronics
Pin Type	Gold-Plated Pins or Gold-Capped Variants
Precious Metals Present	Gold (Au), Silver (Ag), Palladium (Pd) (trace amounts may be present)
Packaging	Bulk Bags, Drums, Boxes, or Pallets
Storage	Store in Dry, Clean Conditions
Recovery Application	Precious Metal Refining and Recycling
Market Use	E-Waste Recycling, Metal Recovery, Electronic Scrap Trading, Collectibles
Typical Grades	Ceramic CPUs with Lids, Ceramic CPUs without Lids, Gold-Cap CPUs, Mixed Ceramic CPUs
Origin	Recovered from Various Global Electronic Sources
Export Status	Available for International Recycling and Scrap Trade Subject to Local Regulations
Quality Standard	Sorted, Clean, and Free from Excess Non-Metallic Contamination